GH6C005B3A/GH6C005B3B GH6C005B5A/GH6C005B5B

■ Features

- Insert frame structure enables easy mounting compared to conventional pin structure.
- (2) Thin and compact package enables thin and compact pick-up design.

GH6C005B3A/B: 4.8mm thickness GH6C005B5A/B: 3.0mm thickness

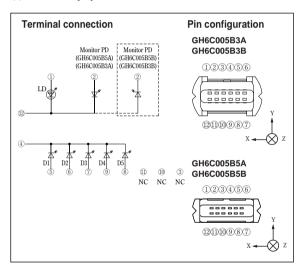
(3) With built-in beam splitter and diffraction grating

■ Model No.

- (1) GH6C005B3A/GH6C005B5A Dual power supply
- (2) GH6C005B3B/GH6C005B5BSingle power supply

■ Applications

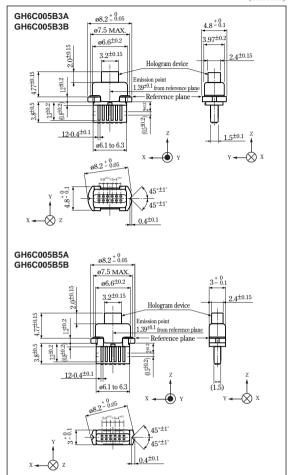
- (1) CD audio players
- (2) Video CD players



Compact Resin type Hologram Laser for CD Audio/Video CD Player

Outline Dimensions

(Unit:mm)



Absolute Maximum Ratings

	Parame	eter	Symbol	Rating	Unit
*1	Optical power output	ıt	Рн	4.3	mW
		Laser		2	V
	Reverse voltage	Monitor photodiode	V_R	30	V
		Signal detection photodiode		15	V
*2	Operating temperat	ure	Topr	-10 to +70	°C
*2	Storage temperatur	e	Tstg	-40 to +85	°C

Tsold

Soldering temperature

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(Tc=25°C)

°C

^{*1} Output power from hologram laser, CW (Continuous Wave) drive

^{*2} Case temperature

^{*3} At the position of 1.6mm or more from the lead base (Within 5s)

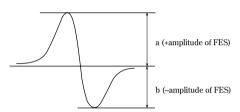
Electro-optical Characteristics

(Vcc=5V, Tc=25°C)

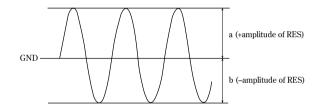
Par	ameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*1 Focal offset		DEF	R _F =6.0μA	-0.7	-	+0.7	μm
*2 Focal error sym	metry	Bres	R _F =6.0μA	-25	-	+25	%
*3 Radial error bala	ance	Bres	P _H =3.0mW	-25	-	+25	%
**4 RF output ampli	tude	Irf	P _H =3.0mW	4.3	7.2	-	μΑ
**5 FES output amp	litude	IFES	R _F =6.0μA	2.6	3.9	5.2	μА
**6 RES output amp	**6 RES output amplitude		R _F =6.0μA	0.7	1.1	1.5	μΑ
Threshold curre	Threshold current		-	-	25	39	mA
Operating curre	Operating current		P _H =3.0mW	-	36	50	mA
Operating voltage	Operating voltage		P _H =3.0mW	-	1.85	2.20	V
Wavelength	Wavelength		P _H =3.0mW	770	780	795	nm
Outt	GH6C005B3A/GH6C005B5A	Im	D 00 W V 15V	0.06	0.32	0.6	mA
Output current	GH6C005B3B/GH6C005B5B	I _m P _H =3.0mW, V _R =15V	0.05	0.2	0.6	mA	
Differential efficiency		ηd	2.0mW I(3.0mW)-I(1.0mW)	0.17	0.27	0.55	mW/mA

^{*1} Distance between FES=0 and jitter minimum point At the condition of FES sensitivity = 20%/1µm

⁽a-b) / (a+b)







- *4 Amplitude of D2+D3+D4 (focal servo ON, radial servo ON)
- *5 D2-D3 (Focal vibration)
- *6 D₁–D₅ (focal servo ON, radial servo OFF)

■ Electro-optical Characteristics of Laser Diode (Design Standard*)

(Tc=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Emission	Parallel S//		-25	-	+25	%		
characteristics	Symmetry	Perpendicular	S⊥	Po=3mW, Into NA=0.11	-15	-	+15	%
		Δx		-80	-	+80	μm	
Misalignment position			Δy	_	-80	-	+80	μm
			Δz		-80	-	+80	μm
Interference pattern intensity		α	Po=3mW	-	-	0.99	-	

■ Electrical Characteristics of Monitor Photodiode (Design Standard*) (GH6C005B3A/GH6C005B5A)

(Tc=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*1 Sensitivity	S		-	0.11	-	mA/mW
Dark current	ID	$V_R=15V$	-	-	150	nA
Terminal capacitance	Ct		-	3.5	-	pF

(GH6C005B3B/GH6C005B5B)

(Tc=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*1 Sensitivity	S	V _R =15V	-	0.07	-	mA/mW
Dark current	ID	v R=13 v	-	-	150	nA
Terminal capacitance	Ct	$V_R=15V$, $f=1MHz$	-	7.7	-	pF

^{*1} For hologram output power

■ Electro-optical Characteristics of Photodiode for Signal Detection (Design Standard*) (GH6C005B3A) (Tc=25°C)

_							
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	*2 Segment
Reverse voltage	V_R	I _R =10µA	15	-	150	V	A, B, C
Dark current	I_{d}	V _R =15V	-	-	10	nA	A, B, C
Wavelength	λ_{p}		-	800	-	nm	A, B, C
Terminal capacitance	Ct	V _R =15V, f=1MHz	1.2	-	5.0	pF	В, С
Terminal capacitance		VR=13V, I=1WIHZ	1.4	-	5.8	pF	A
	Isc	Ev=1 000lx	130	210	340	nA	A
*3 Short circuit current			50	80	110	nA	В
			70	115	160	nA	С
Dognongo timo	tr, tf	$V_R=15V$, $R_L=180\Omega$	-	10	200	ns	A
Response time			-	10	120	ns	B, C

^{*2} Applicable divisions correspond to output terminals.

D1	
D2	D4
D3	D4
D5	

Segment No.	Output
D 1, D 5	A
D 2, D 5	В
D 3, D 5	C

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^{®3} Current of each segment (At other segments, Anode and Cathode is short-circuited.)

^{*} These parameters are not guaranteed performance, but general specifications of each optical element which makes up a hologram laser.

[•] Please refer to the chapter "Handling Precautions"

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